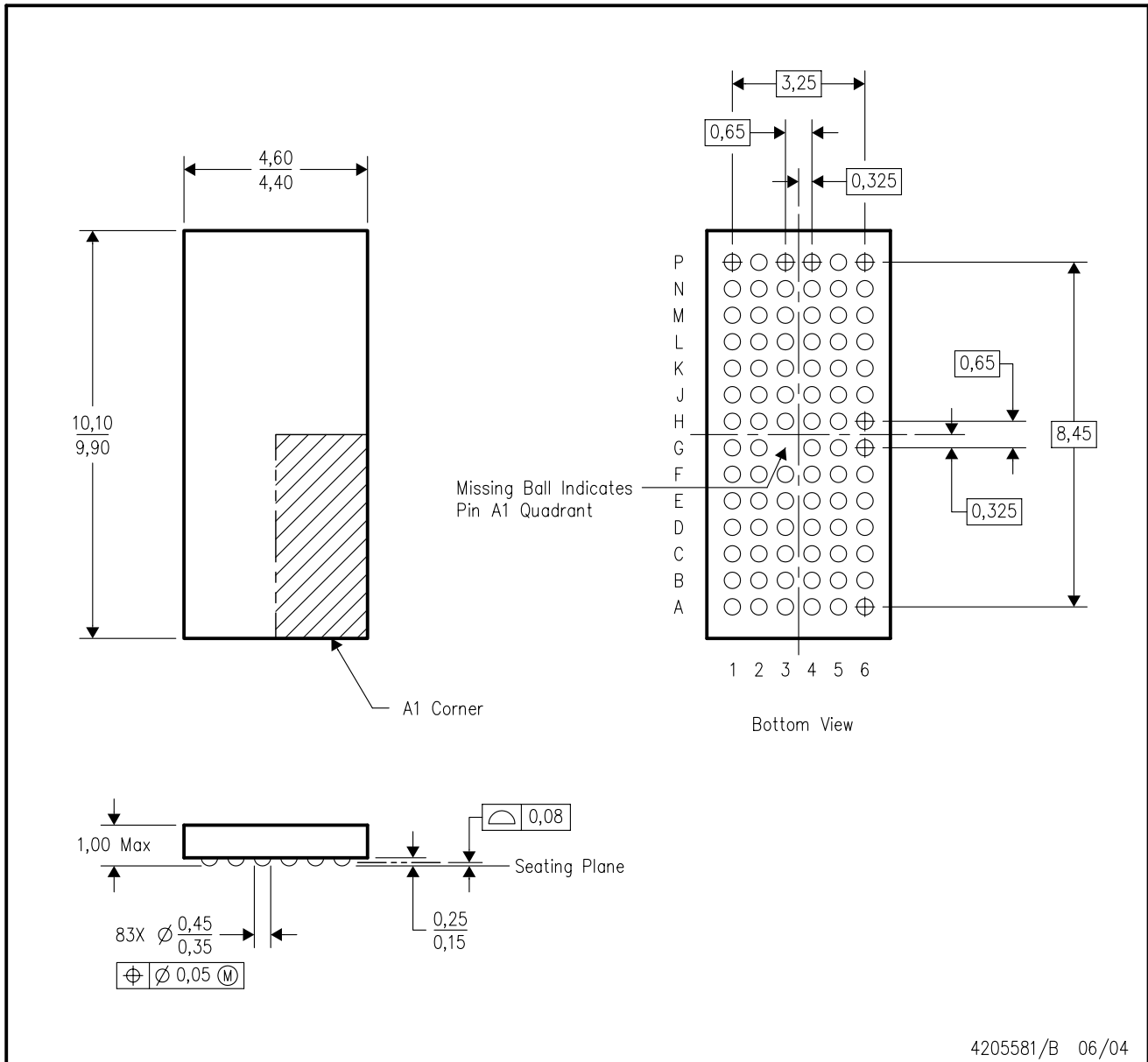


GRG (R-PBGA-N83)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. JEDEC MO-225 registration is pending.
 - D. This package is tin-lead (SnPb). Refer to the 83 ZRG package (drawing 4205696) for lead-free.

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